

## CMOS 4-Bit Microcontroller

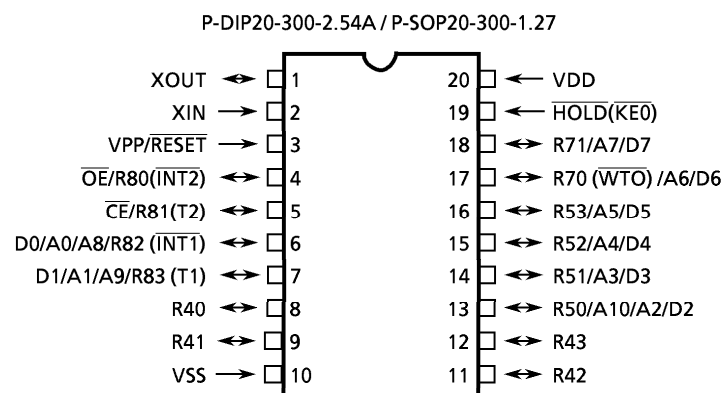
# TMP47P202VP TMP47P202VM

The TMP47P202V is the system evaluation LSI of TMP47C102/202 with a 16 Kbit one-time PROM. The TMP47P202V programs / verifies using an adapter socket to connect with PROM programmer, as it is in TMM27256AD.

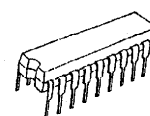
In addition, the TMP47P202V and the TMP47C102/202 are pin compatible. The TMP47P202V operates as the same as the TMP47C102/202 by programming to the internal PROM.

| Part No.    | ROM          | RAM         | Package           | OTP     |
|-------------|--------------|-------------|-------------------|---------|
| TMP47P202VP | OTP          |             | P-DIP20-300-2.54A | BM1187  |
| TMP47P202VM | 2048 × 8-bit | 128 × 4-bit | P-SOP20-300-1.27  | BM11113 |

## Pin Assignment (Top View)

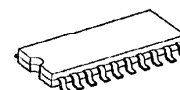


P-DIP20-300-2.54A



TMP47P202VP

P-SOP20-300-1.27



TMP47P202VM

000707EBA1

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**Pin Function**

The TMP47P202V has MCU mode and PROM mode.

## (1) MCU mode

The TMP47C102/202 and the TMP47P202V are pin compatible.

## (2) PROM mode

| Pin Name          | Input / Output | Functions                                     | Pin Name (MCU mode) |
|-------------------|----------------|-----------------------------------------------|---------------------|
| D0 / A0 / A8      | I/O            | Data inputs / outputs or Address inputs       | R82                 |
| D1 / A1 / A9      |                |                                               | R83                 |
| D2 / A2 / A10     |                |                                               | R50                 |
| D3 / A3           |                |                                               | R51                 |
| D4 / A4           |                |                                               | R52                 |
| D5 / A5           |                |                                               | R53                 |
| D6 / A6           |                |                                               | R70                 |
| D7 / A7           |                |                                               | R71                 |
| $\overline{OE}$   | Input          | Output Enable input                           | R80                 |
| $\overline{CE}$   |                | Chip Enable input                             | R81                 |
| VPP               | Power supply   | + 12.5 V / 5 V (Program supply voltage)       | $\overline{RESET}$  |
| VCC               |                | + 5 V                                         | VDD                 |
| VSS               |                | 0 V                                           | VSS                 |
| R43 to R40        | I/O            | Be fixed to low level.                        |                     |
| $\overline{HOLD}$ | Input          | PROM mode setting pin. Be fixed to low level. |                     |
| XIN               | Input          | Input the clock from the external oscillator. |                     |
| XOUT              | Input          | PROM control input                            |                     |

## Operational Description

The following is an explanation of hardware configuration and operation in relation to the TMP47P202V. The TMP47P202V is the same as the TMP47C102/202 except that an OTP is used instead of a built-in mask ROM.

### 1. Operation mode

The TMP47P202V has an MCU mode and a PROM mode.

#### 1.1 MCU mode

The MCU mode is set by attaching a resonator between the XIN and XOUT pins. Operation in the MCU mode is the same as for the TMP47C102/202. In the TMP47P202V, RC oscillation is impossible.

##### 1.1.1 Program Memory

The program storage area is the same as for the TMP47C202. Don't use the addresses 400 to 7FF<sub>H</sub> when using the TMP47P102V to check TMP47C102 operation.

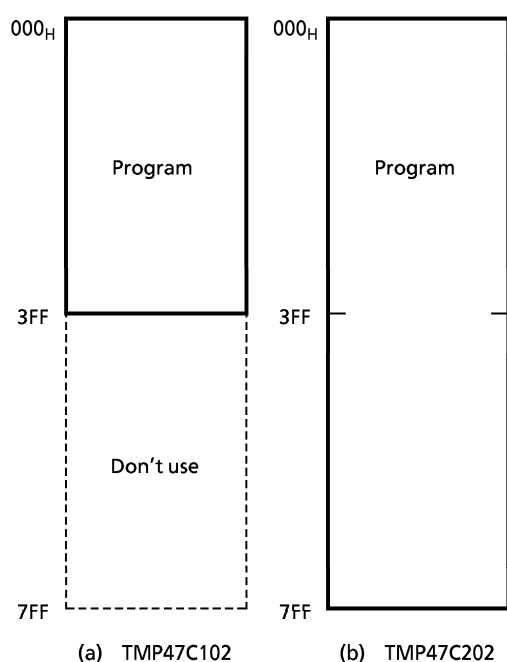


Figure 1-1. Program Area

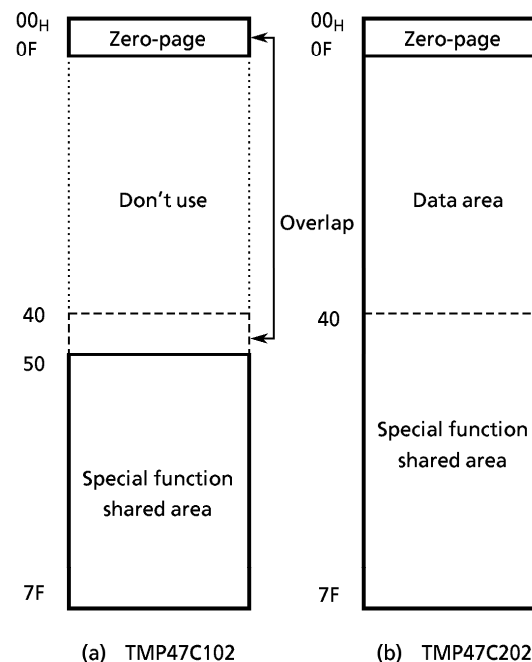


Figure 1-2. RAM Address Assignment

##### 1.1.2 Data Memory

The TMP47P202V has 128×4-bit of data memory (RAM). When the TMP47P202V is used as the TMP47C102 evaluator, programming should be performed assuming that the RAM is assigned to address 00 to 0F<sub>H</sub> and 50 to 7F<sub>H</sub> as show in Figure 1-2. When the BM47C203 (emulator) is used as the TMP47C102 evaluator, it is same.

Further, zero-page (addresses 00 to 0F<sub>H</sub>) and special function shared area (stack location 0 to 3) are overlapped on the TMP47C102.

## Electrical Characteristics

## Absolute Maximum Ratings

(V<sub>SS</sub> = 0 V)

| Parameter                       | Symbol             | Pins        | Ratings                        | Unit |
|---------------------------------|--------------------|-------------|--------------------------------|------|
| Supply Voltage                  | V <sub>DD</sub>    |             | – 0.3 to 6.5                   | V    |
| Program Voltage                 | V <sub>PP</sub>    | RESET / VPP | – 0.3 to 13.0                  | V    |
| Input Voltage                   | V <sub>IN</sub>    |             | – 0.3 to V <sub>DD</sub> + 0.3 | V    |
| Output Voltage                  | V <sub>OUT</sub>   |             | – 0.3 to V <sub>DD</sub> + 0.3 | V    |
| Output Current (Per 1 pin)      | I <sub>OUT1</sub>  | Port R4     | 30                             | mA   |
|                                 | I <sub>OUT2</sub>  | Port R5     | 15                             |      |
|                                 | I <sub>OUT3</sub>  | Port R7, R8 | 3.2                            |      |
| Output Current (Total)          | Σ I <sub>OUT</sub> | Port R4, R5 | 60                             | mA   |
| Power Dissipation [Topr = 70°C] | PD                 |             | 300                            | mW   |
| Soldering Temperature (time)    | Tsld               |             | 260 (10 s)                     | °C   |
| Storage Temperature             | Tstg               |             | – 55 to 125                    | °C   |
| Operating Temperature           | Topr               |             | – 30 to 70                     | °C   |

**Note:** The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

## Recommended Operating Conditions

(V<sub>SS</sub> = 0 V, Topr = – 30 to 70°C)

| Parameter          | Symbol           | Pins                    | Conditions                     | Min                    | Max                    | Unit |
|--------------------|------------------|-------------------------|--------------------------------|------------------------|------------------------|------|
| Supply Voltage     | V <sub>DD</sub>  |                         | fc = 6.0 MHz                   | 4.5                    | 5.5                    | V    |
|                    |                  |                         | fc = 4.2 MHz                   | 2.7                    |                        |      |
|                    |                  |                         | HOLD mode                      | 2.0                    |                        |      |
| Input High Voltage | V <sub>IH1</sub> | Except Hysteresis Input | In the normal operating area   | V <sub>DD</sub> × 0.7  | V <sub>DD</sub>        | V    |
|                    | V <sub>IH2</sub> | Hysteresis Input        |                                | V <sub>DD</sub> × 0.75 |                        |      |
|                    | V <sub>IH3</sub> |                         | In the HOLD mode               | V <sub>DD</sub> × 0.9  |                        |      |
| Input Low Voltage  | V <sub>IL1</sub> | Except Hysteresis Input | In the normal operating area   | 0                      | V <sub>DD</sub> × 0.3  | V    |
|                    | V <sub>IL2</sub> | Hysteresis Input        |                                |                        | V <sub>DD</sub> × 0.25 |      |
|                    | V <sub>IL3</sub> |                         | In the HOLD mode               |                        | V <sub>DD</sub> × 0.1  |      |
| Clock Frequency    | fc               | XIN, XOUT               | V <sub>DD</sub> = 4.5 to 5.5 V | 0.4                    | 6.0                    | MHz  |
|                    |                  |                         | V <sub>DD</sub> = 2.7 to 5.5 V |                        | 4.2                    |      |

**Note:** The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

## DC Characteristics

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = – 30 to 70°C)

| Parameter                                           | Symbol           | Pins                    | Conditions                                             | Min | Typ. | Max | Unit |
|-----------------------------------------------------|------------------|-------------------------|--------------------------------------------------------|-----|------|-----|------|
| Hysteresis Voltage                                  | V <sub>HS</sub>  | Hysteresis Input        |                                                        | –   | 0.7  | –   | V    |
| Input Current                                       | I <sub>IN1</sub> | RESET, HOLD             | V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V / 0 V | –   | –    | ± 2 | μA   |
|                                                     | I <sub>IN2</sub> | Open drain output ports |                                                        |     |      |     |      |
| Input Resistance                                    | R <sub>IN</sub>  | RESET                   |                                                        | 100 | 220  | 450 | kΩ   |
| Output Leakage Current                              | I <sub>LO</sub>  | Open drain output ports | V <sub>DD</sub> = 5.5 V, V <sub>OUT</sub> = 5.5 V      | –   | –    | 2   | μA   |
| Output Low Voltage                                  | V <sub>OL</sub>  | Except XOUT and port R4 | V <sub>DD</sub> = 4.5 V, I <sub>OL</sub> = 1.6 mA      | –   | –    | 0.4 | V    |
| Output Low Current                                  | I <sub>OL1</sub> | Port R4                 | V <sub>DD</sub> = 4.5 V, V <sub>OL</sub> = 1.0 V       | –   | 20   | –   | mA   |
|                                                     | I <sub>OL2</sub> | Port R5                 |                                                        | –   | 7    | –   |      |
| Supply Current<br>(in the Normal<br>operating mode) | I <sub>DD</sub>  |                         | V <sub>DD</sub> = 5.5 V, f <sub>c</sub> = 4 MHz        | –   | 2    | 4   | mA   |
|                                                     |                  |                         | V <sub>DD</sub> = 3.0 V, f <sub>c</sub> = 4 MHz        | –   | 1    | 2   |      |
|                                                     |                  |                         | V <sub>DD</sub> = 3.0 V, f <sub>c</sub> = 400 kHz      | –   | 0.5  | 1   |      |
| Supply Current<br>(in the HOLD<br>operating mode)   | I <sub>DDH</sub> |                         | V <sub>DD</sub> = 5.5 V                                | –   | 0.5  | 10  | μA   |

Note 1: Typ. values show those at T<sub>opr</sub> = 25°C, V<sub>DD</sub> = 5 V.

Note 2: Input Current I<sub>IN1</sub>: The current through resistor is not included.

Note 3: Supply Current: V<sub>IN</sub> = 5.3 V / 0.2 V (V<sub>DD</sub> = 5.5 V) or 2.8 V / 0.2 V (V<sub>DD</sub> = 3.0 V)

## AC Characteristics

(V<sub>SS</sub> = 0 V, T<sub>opr</sub> = – 30 to 70°C)

| Parameter                    | Symbol           | Conditions                   | Min | Typ. | Max | Unit |
|------------------------------|------------------|------------------------------|-----|------|-----|------|
| Instruction Cycle Time       | t <sub>cy</sub>  | VDD = 4.5 to 5.5 V           | 1.3 | –    | 20  | μs   |
|                              |                  | VDD = 2.7 to 5.5 V           | 1.9 |      |     |      |
| High level Clock pulse Width | t <sub>WCH</sub> | For external clock operation | 80  | –    | –   | ns   |
| Low level Clock pulse Width  | t <sub>WCL</sub> |                              |     |      |     |      |

## Recommended Oscillating Conditions

(V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 2.7 to 5.5 V, T<sub>opr</sub> = – 30 to 70°C)

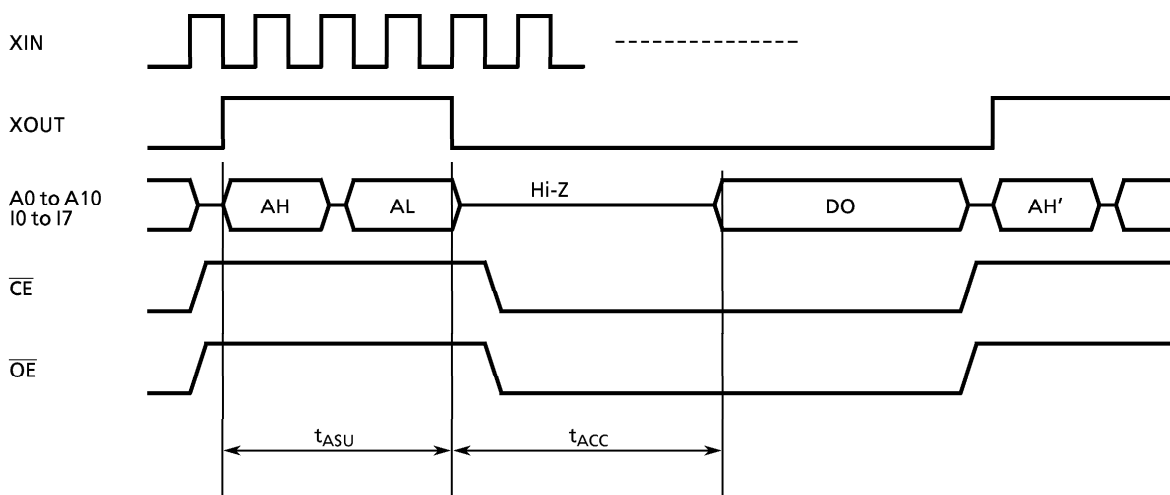
Recommended oscillating conditions of the TMP47P202V are equal to the TMP47C102/202's but RC oscillation is impossible.

## DC/AC Characteristics

(V<sub>SS</sub> = 0 V)

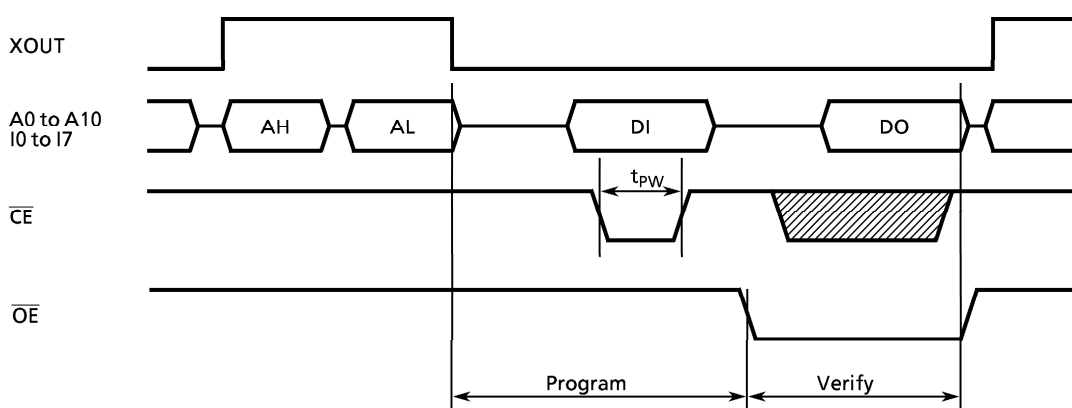
## (1) Read Operation

| Parameter                 | Symbol           | Condition                      | Min                   | Typ. | Max                   | Unit |
|---------------------------|------------------|--------------------------------|-----------------------|------|-----------------------|------|
| Output Level High Voltage | V <sub>IH4</sub> |                                | V <sub>CC</sub> × 0.7 | –    | V <sub>CC</sub>       | V    |
| Output Level Low Voltage  | V <sub>IL4</sub> |                                | 0                     | –    | V <sub>CC</sub> × 0.3 | V    |
| Supply Voltage            | V <sub>CC</sub>  |                                | 4.75                  | –    | 6.0                   | V    |
| Programming Voltage       | V <sub>PP</sub>  |                                |                       |      |                       |      |
| Address Set-up Time       | t <sub>ASU</sub> |                                | 350                   | –    | –                     | ns   |
| Address Access Time       | t <sub>ACC</sub> | V <sub>CC</sub> = 5.0 ± 0.25 V | –                     | –    | 300                   | ns   |



## (2) High Speed Programming Operation

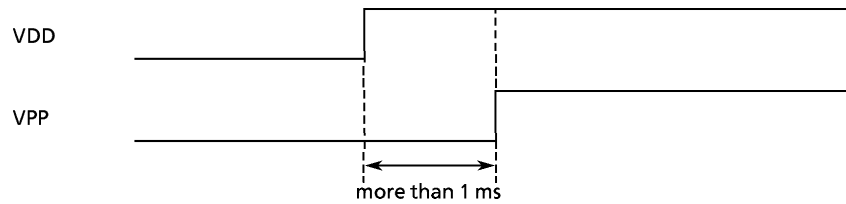
| Parameter                     | Symbol    | Condition                 | Min                 | Typ.  | Max                 | Unit |
|-------------------------------|-----------|---------------------------|---------------------|-------|---------------------|------|
| Input High Voltage            | $V_{IH4}$ |                           | $V_{CC} \times 0.7$ | –     | $V_{CC}$            | V    |
| Input Low Voltage             | $V_{IL4}$ |                           | 0                   | –     | $V_{CC} \times 0.3$ | V    |
| Supply Voltage                | $V_{CC}$  |                           | 4.75                | –     | 6.0                 | V    |
| $V_{PP}$ Power Supply Voltage | $V_{PP}$  |                           | 12.0                | 12.50 | 13.00               | V    |
| Programming Pulse Width       | $t_{PW}$  | $V_{CC} = 6.0 \pm 0.25$ V | 0.95                | 1.0   | 1.05                | ms   |



Note: DO ; Data output (I0 to I7), AL ; Address input (A0 to A7)  
DI ; Data input (I0 to I7), AH ; Address input (A8 to A10)

*Note: There are some PROM programmer types which cannot program OTP.*

*In TMP47P202V, VPP pin is also used as RESET pin. To set a mode, REST/VPP pin must be set to "low" during 1 ms and more after the rising of power-on and the rising of VDD electrical power.*



**Recommend EPROM programmer**

**TYPE**

R4945 (ADVANTEST)

UNISITE (DATA I/O)

AF - 9706 (ANDO)

PECKER - 11 (AVAL DATA)